



**TECHNICAL UNIVERSITY
OF CRETE**

Embedded System for Photographic FLASH Triggering

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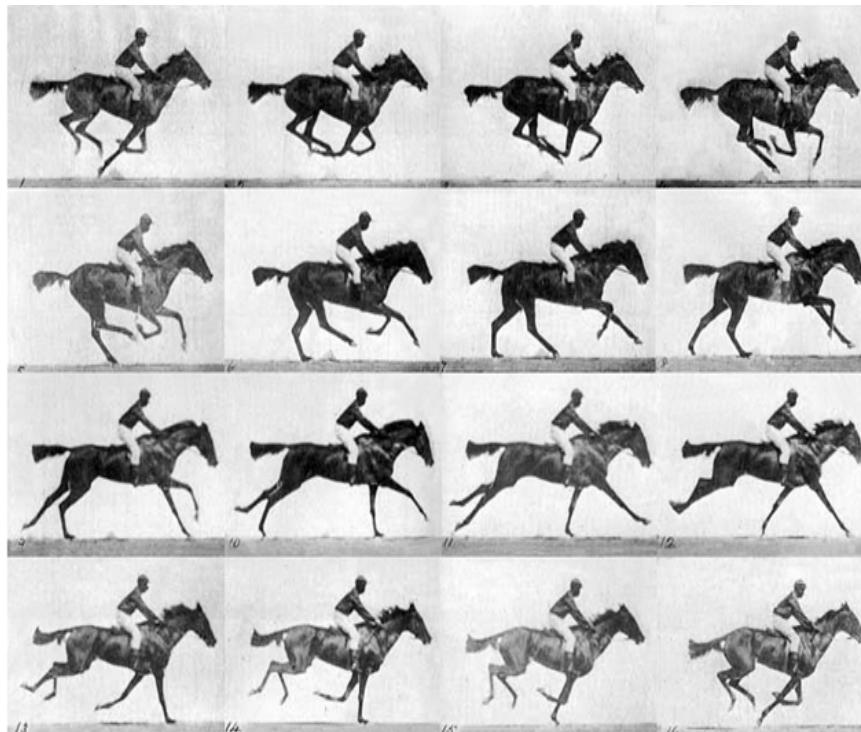
Assoc.Prof. I. Papaefstathiou (AUTH)

Aims

- Design of photographic flash triggering system
- Wireless sensor triggers
- Low cost (< 60\$)
- Open Source
- Readily available components
- Easy construction

High Speed Photography

- Multiple consecutive shots at high frequency
- Single image capturing a specific moment in time

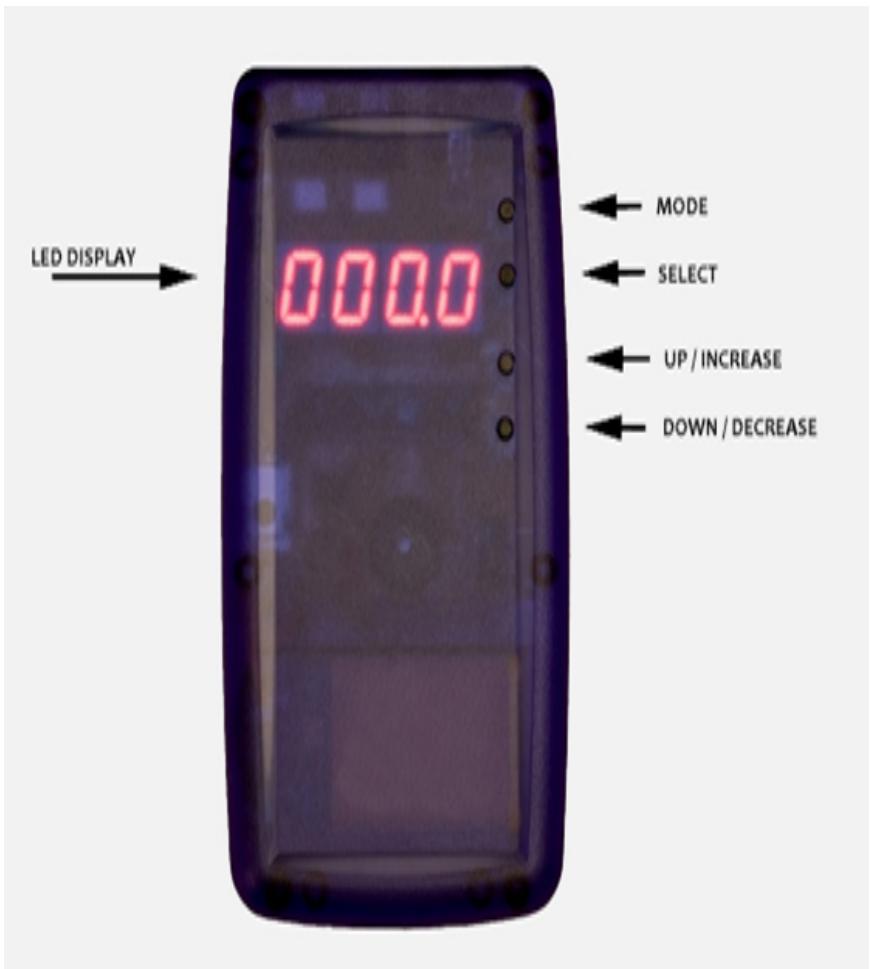


E. Muybridge, *Descriptive Zoopraxography*

<http://www.cameraaxe.com/wp/>

- SMPTE, “Society of Motion Picture and Television Engineers”, www.smpte.org/home, 2007. [Online]. Available: <http://www.smpte.org/home>
- J. E. Field, “High-speed photography,” *Contemporary Physics*, 1983. [Online]. Available: https://en.wikipedia.org/wiki/High-speed_photography#Notes

Triggering Systems



<http://www.universaltimer.com/info1.html>

Common Principles and Similar Architectures

- Microcontrollers → computing units
- Sensor Measurements → Triggers

Human Reaction Time

- Slow (mean 250 ms)
- Reaction Time (Tr) = Stimulus Time to Brain (Ts) + Brain to Body Command Time (Tb)
- Age, Health State, Gender and Type of Stimulus as Factors for Reaction Times

- A. Jain, R. Bansal, A. Kumar, and K. D. Singh, “A comparative study of visual and auditory reaction times on the basis of gender and physical activity levels of medical first year students.,” *Int. J. Appl. basic Med. Res.*, vol. 5, no. 2, pp. 124–7, 2015.
- A. T. Welford, “Speed-accuracy trade-off and information processing dynamics,” Academic Press, 1934.
- F. Mawase, D. Lopez, P. A. Celnik, and A. M. Haith, “Movement Repetition Facilitates Response Preparation,” 2018.
- R. J. Kosinski, “A Literature Review on Reaction Time.”

Duration of Interesting Phenomena



- Animals (98 – 389 km/h)
- Popping balloons (5-10 ms)
- Bullets (120 – 1700 m/s)
- Lightning (100 – 200 ms)
- Objects Breaking (no specific value)

- N. C. C. Sharp, "Timed running speed of a cheetah (*Acinonyx jubatus*)," *J. Zool.*, vol. 241, no. 3, pp. 493–494, Mar. 1997.
- High-Velocity Falcon | National Geographic, *National Geographic* , 2007.
- B. Wilburn, N. Joshi, V. Vaish, M. Levoy, and M. Horowitz, "High-speed videography using a dense camera array," *Proc. 2004 IEEE Comput. Soc. Conf. Comput. Vis. Pattern Recognition, 2004. CVPR 2004.*, vol. 2, pp. 294–301, 2004

Features and Specifications

Main Features

- 2 sensors with changeable threshold
- Triggering of one flash/camera
- Wireless Sensor Connection
- Two trigger functions
- Selectable Trigger Delay



Specifications

- System Latency : < 5 ms
- Hardware:
 - 3 computing units
 - 3 wireless nodes
 - 1 OLED screen
 - 1 button
- Total Cost : < \$60
- Computing Units' I/O : > 9 I/O Pins

Technology Mapping : Criteria

- Performance
- Cost and Availability
- Power Consumption
- Latency (for Wireless Communication)

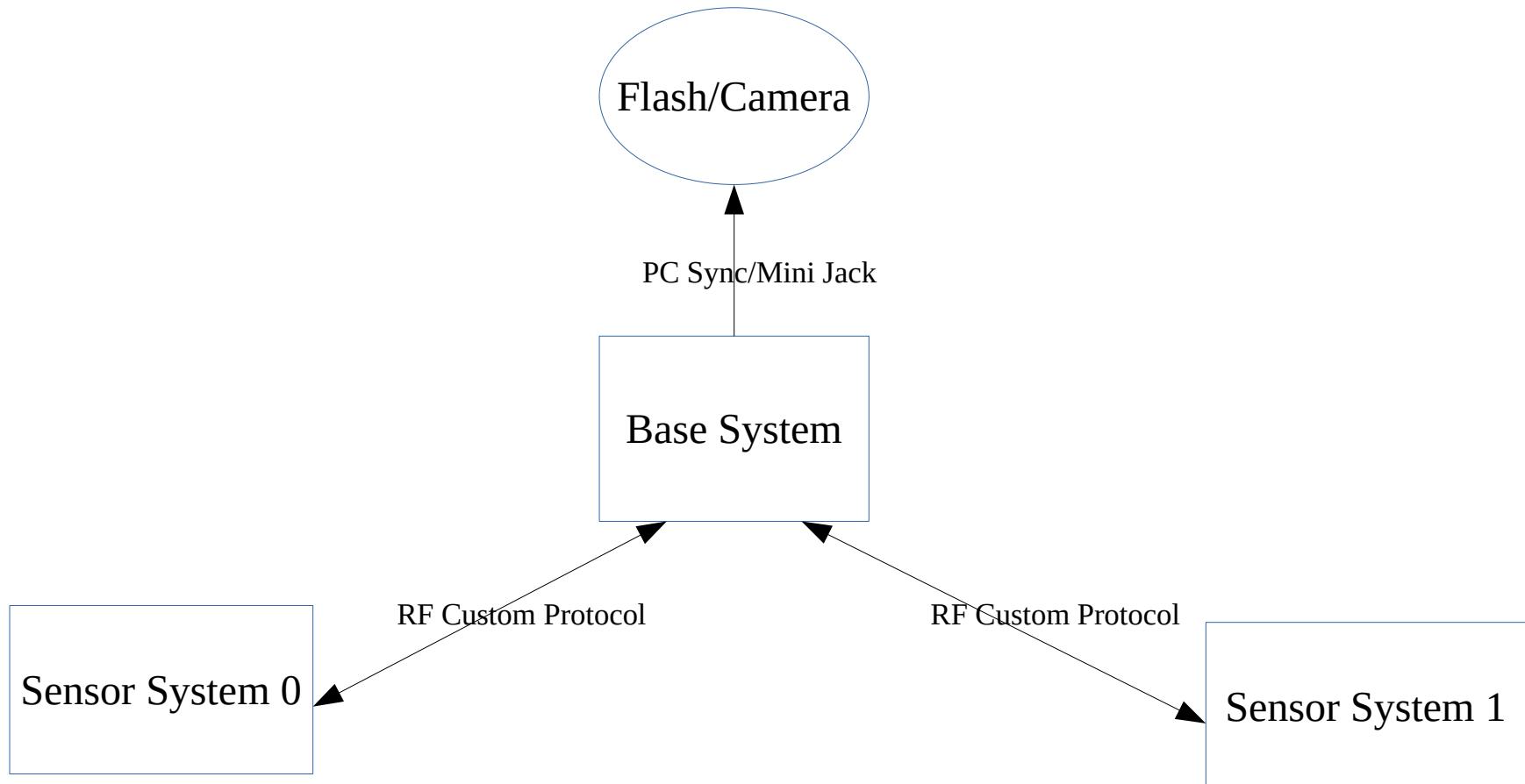
Technology Mapping : Computing Units

Technology	Frequency	Cost	Power Consumption
CPU	> 1 GHz	> \$40	> 25 W (min 5 W)
FPGA	> 100 MHz	> \$80	> W
<i>MCU</i>	<i>> 10 MHz</i>	<i>> \$1-5</i>	<i>< 500 mW</i>
Goal	> 1 MHz	< \$60	< W

Technology Mapping : Wireless Communication

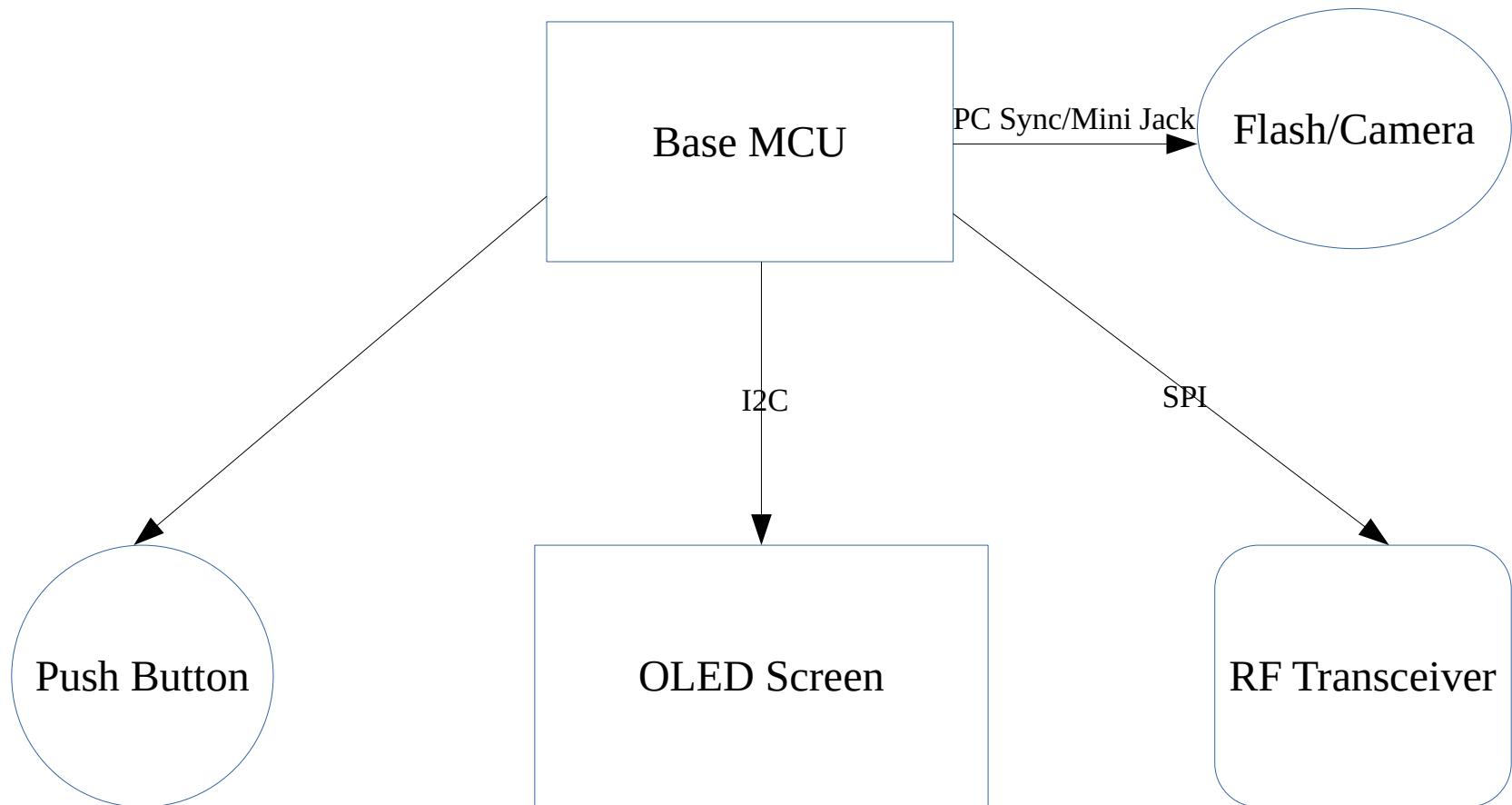
Technology	Estimation of Maximum Latency	Mandatory Optical Contact	Cost	Versatile	Typical Latency Value
Optical	Yes	Yes	> \$3	No	< 100 us
WiFi	No	No	> \$3.6	No	> 25 ms
Bluetooth	No	No	> \$6.3	No	> 25 ms
Zigbee	No	No	> \$45	No	> 25 ms
RF	Yes	No	> \$2.4	Yes	< 1 ms

General System Model



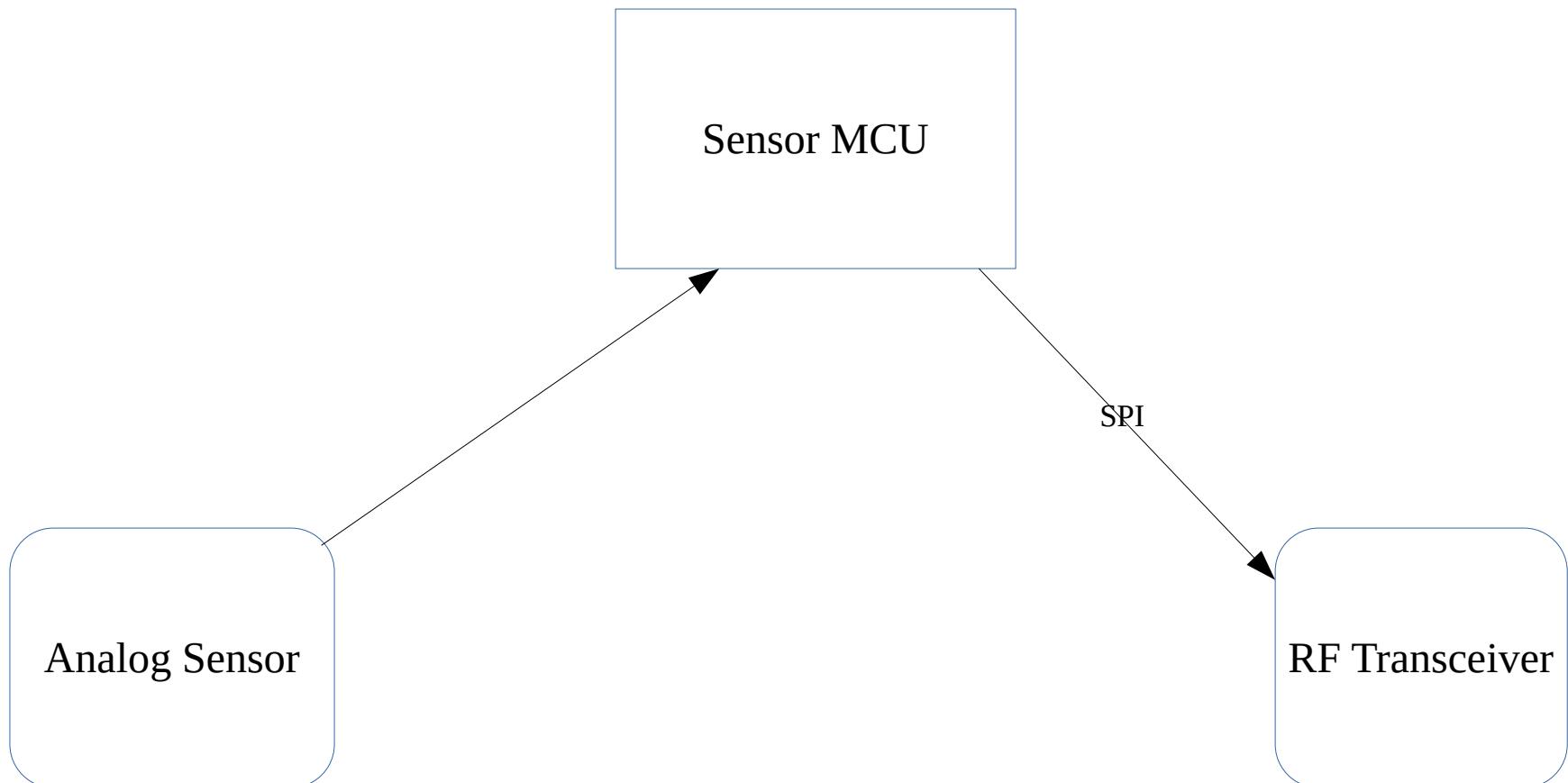
System Model Diagram

Base Subsystem Model



Base Subsystem Model Diagram

Sensor Subsystem Model



Sensor Subsystem Model Diagram

Comparison with Other Systems

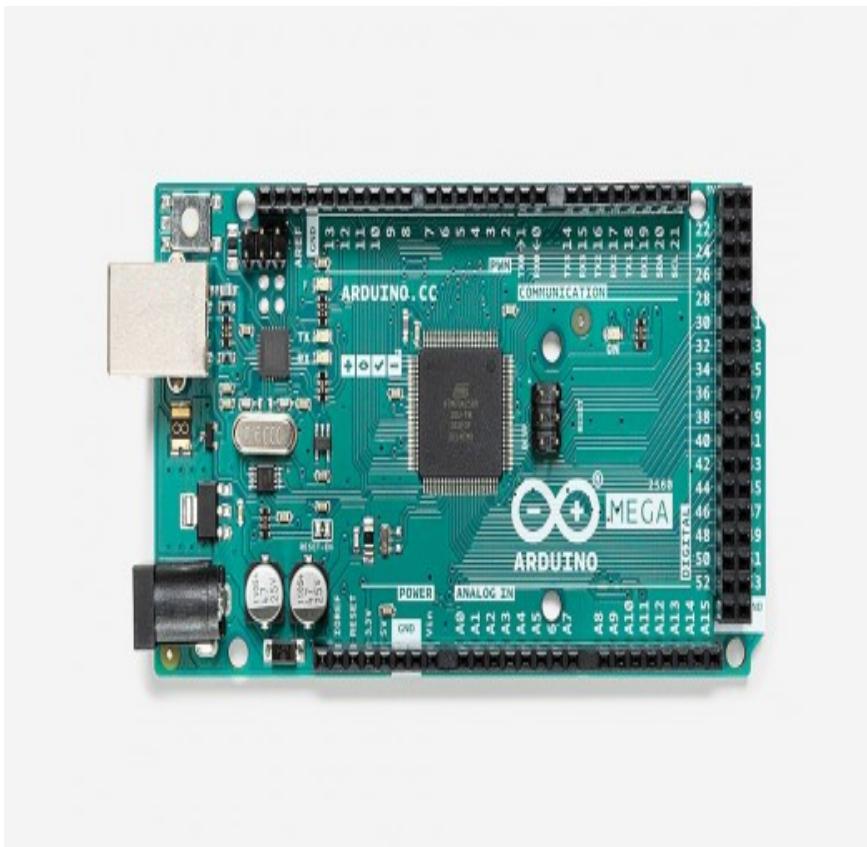
Similarities

- Use of sensors for triggers
- Base responsible for:
 - user interface
 - checking trigger function
 - triggering

Differences

- Less centralized system
- Dedicated MCU for each sensor
- Wireless communication

Base Subsystem MCU



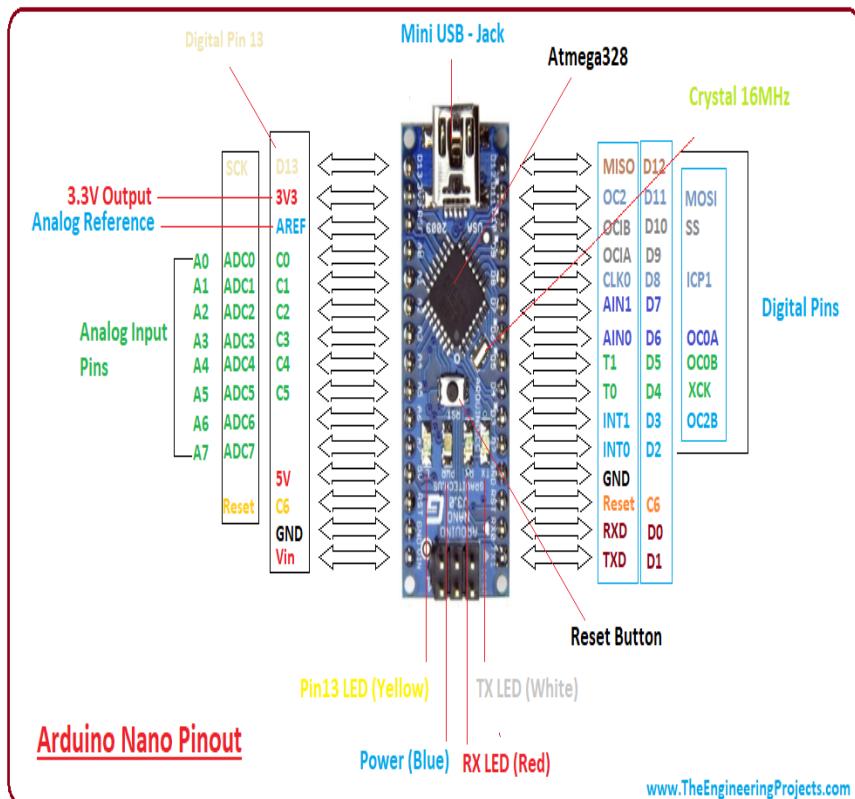
<https://www.microchip.com/wwwproducts/en/ATmega2560>

Arduino Mega 2560

- 16 MHz
- 16 Analog Inputs, 54 Digital I/O
- I2C, SPI, Serial support
- Four 16-bit timers and two 8-bit timers
- 256 kbyte Flash/8 kbyte SRAM
- Open platform → Well supported libraries
- Low price (< 8\$)

- *Arduino, “Arduino Mega 2560 Rev3 | Arduino Official Store,” Arduino. [Online]. Available: <https://store.arduino.cc/arduino-mega-2560-rev3>*
- *Microchip Technology Inc., “ATmega640/V-1280/V-1281/V-2560/V-2561/V.” Microchip Technology Inc., p. 436.*

Sensor Subsystem MCU



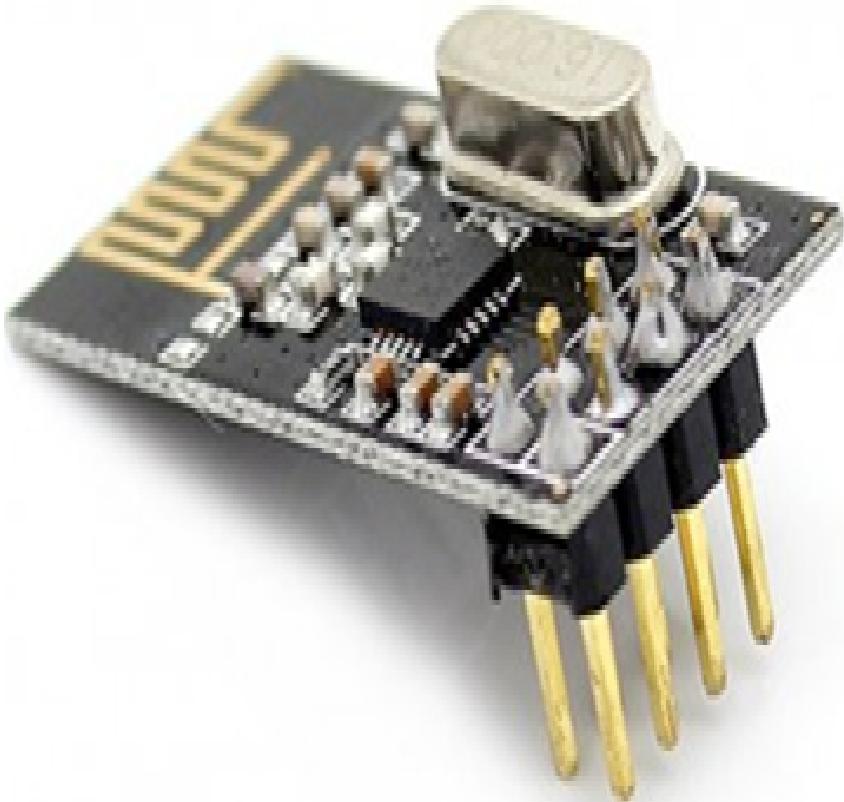
Arduino Nano V3

- Same architecture with Arduino Mega 2560
- 16 MHz
- 8 Analog Inputs, 22 Digital I/O pins
- 32 kbyte Flash/2 kbyte SRAM
- Low price (< 3\$)

<https://www.theengineeringprojects.com/2018/06/introduction-to-arduino-nano.html>

- Arduino, “Arduino Nano.” [Online]. Available: <https://store.arduino.cc/arduino-nano>
- Microchip Technology Inc., “ATmega328P 8-bit AVR.” Microchip Technology Inc., p. 294.

RF Transceiver Module



nRF24L01+ by Nordic Semiconductors

- RF Transceiver
- SPI Interface
- 2.4 GHz band, 126 channels, 2 Mbps
- Low Power Consumption (max 13.5 mA)
- RX → TX or TX → RX in 130 us, total time < 230 us

<http://robotechshop.com/shop/module/nrf24l01/?v=f214a7d42e0d>

- Nordic, “nRF24L01+ Single Chip 2.4GHz Transceiver Product Specification v1.0,” *Build. Res.*, no. 1, p. 78, 2008

Other Hardware

Generic 0.92 inch I2C OLED Screen

- OLED → Low Power Consumption
- High contrast
- Easily available
- Low cost (< 3\$)

Sensors

- Analog
- 3-pin
- Support for 2-pin simple components
- 0-5 V Voltage Range
- Draw current < 40 mA

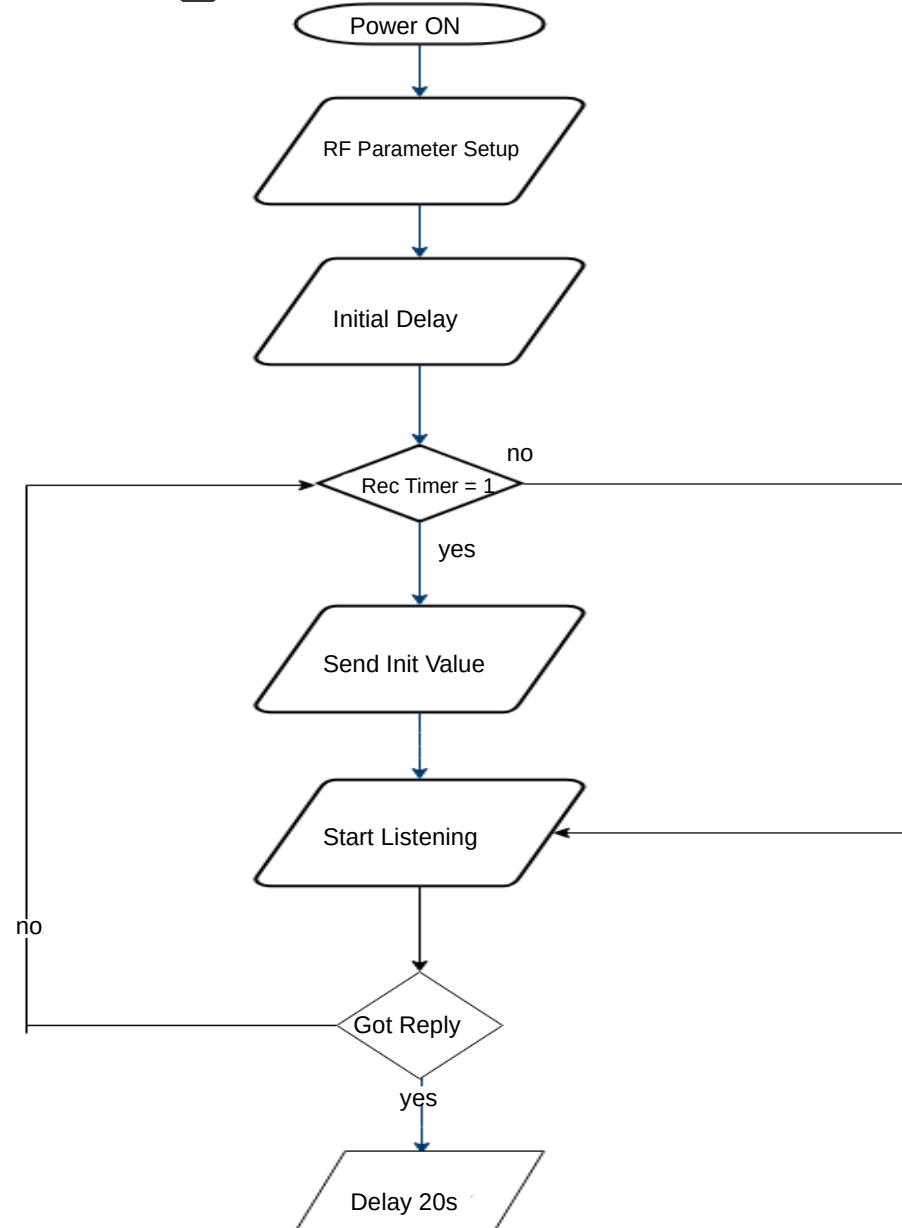
Bypassing Enhanced ShockBurst

- Automatic ACKs → Less Deterministic
- Need for ACKs only during:
 - Sensor Recognition
 - Change of system state
- Fewer packet transmissions
- Reduced power consumption

Custom Protocol

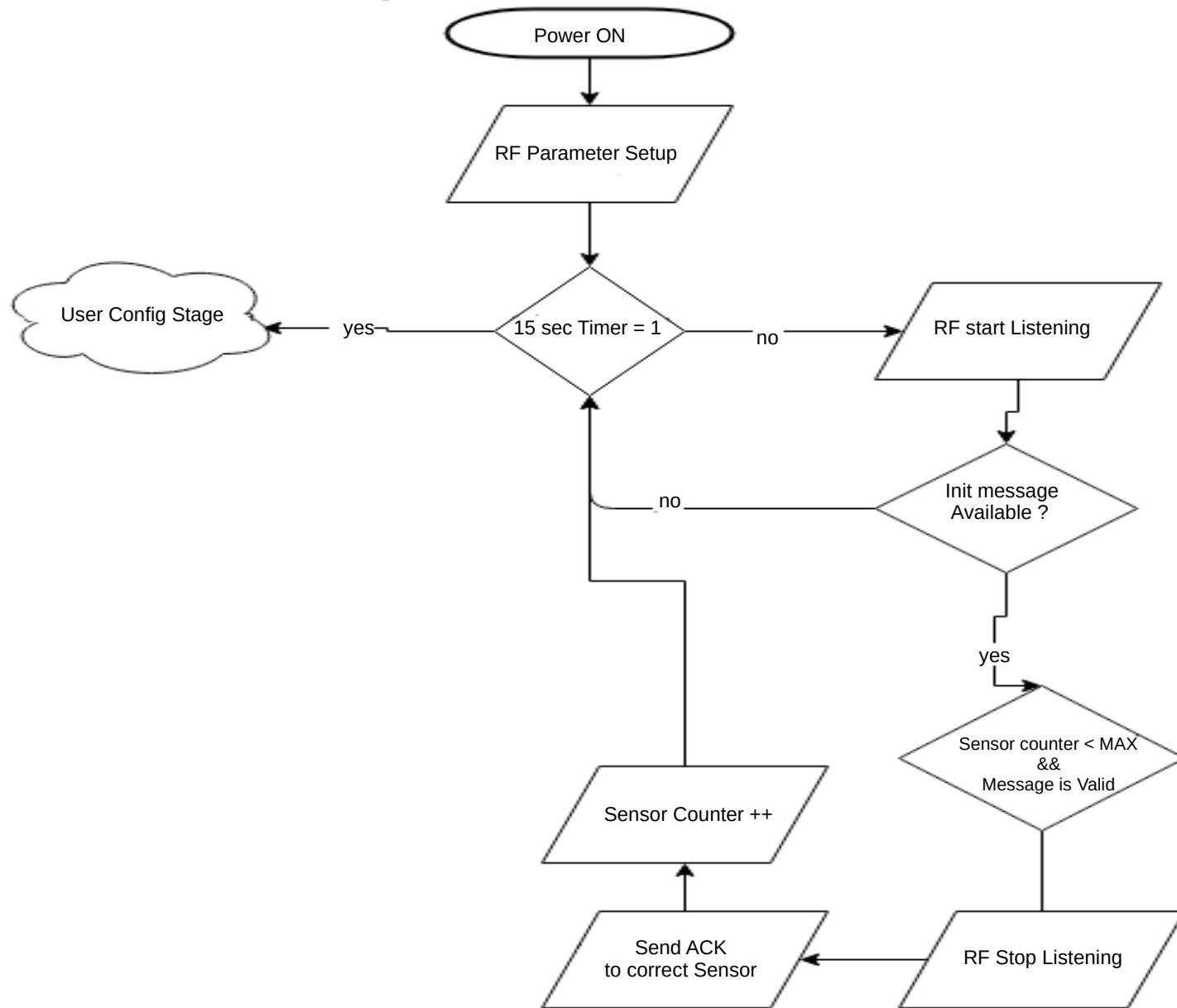
- Low latency communication
- Event based changes
- Event representation → Predetermined value
- Same state for every subsystem

Sensor Recognition : Sensor Subsystem

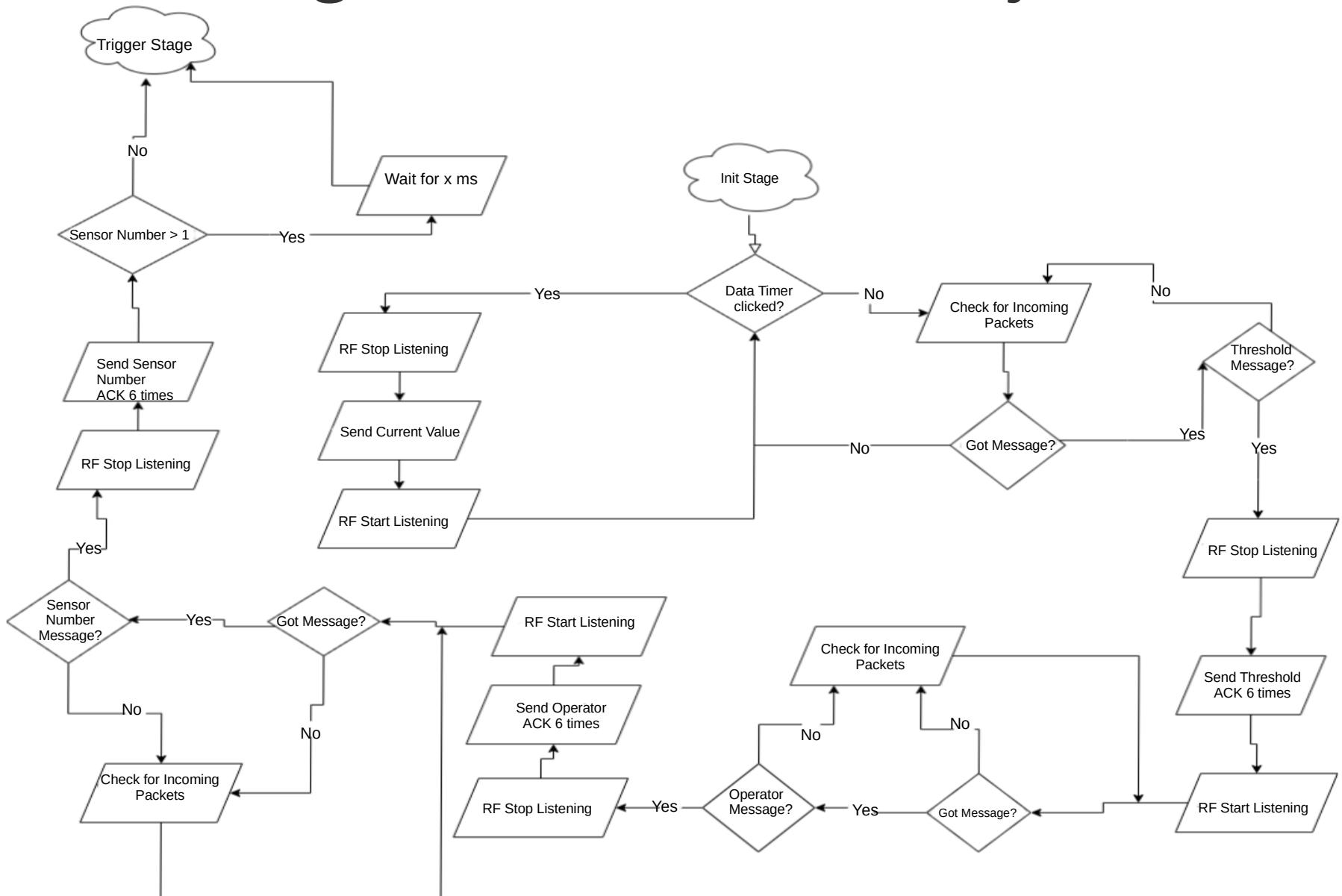


Sensor recognition state flowchart for sensor subsystem

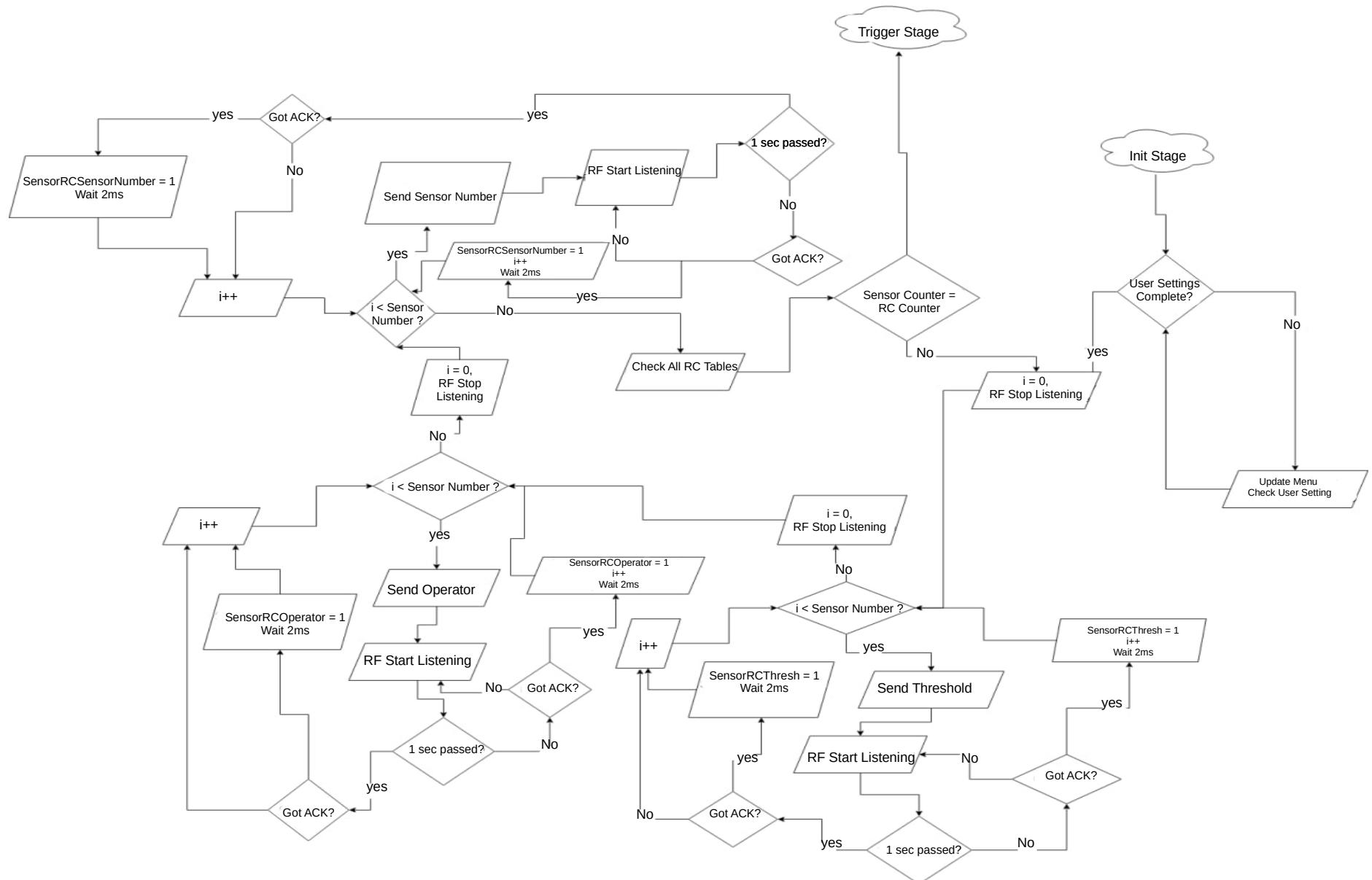
Sensor Recognition : Base Subsystem



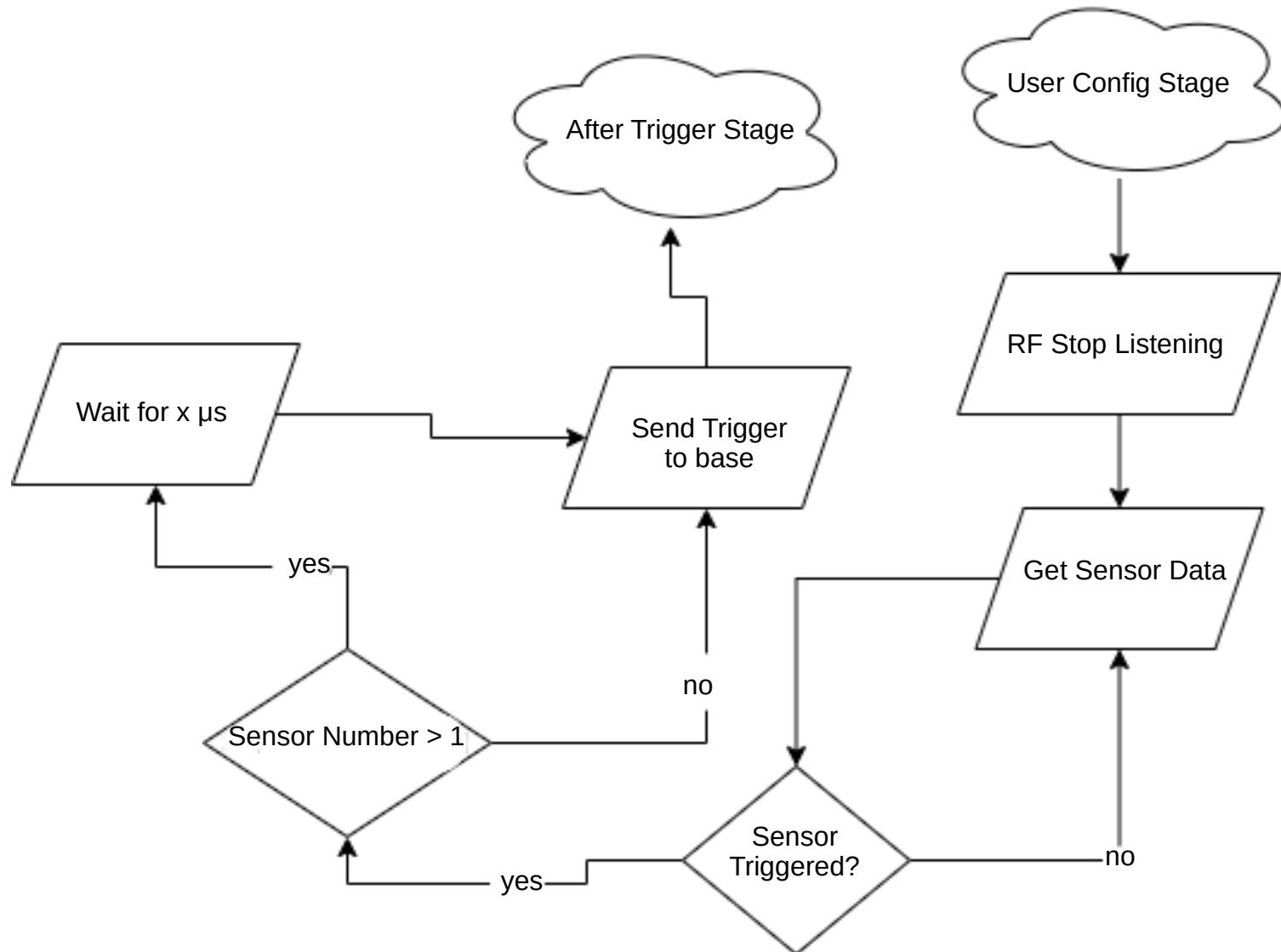
Configuration : Sensor Subsystem



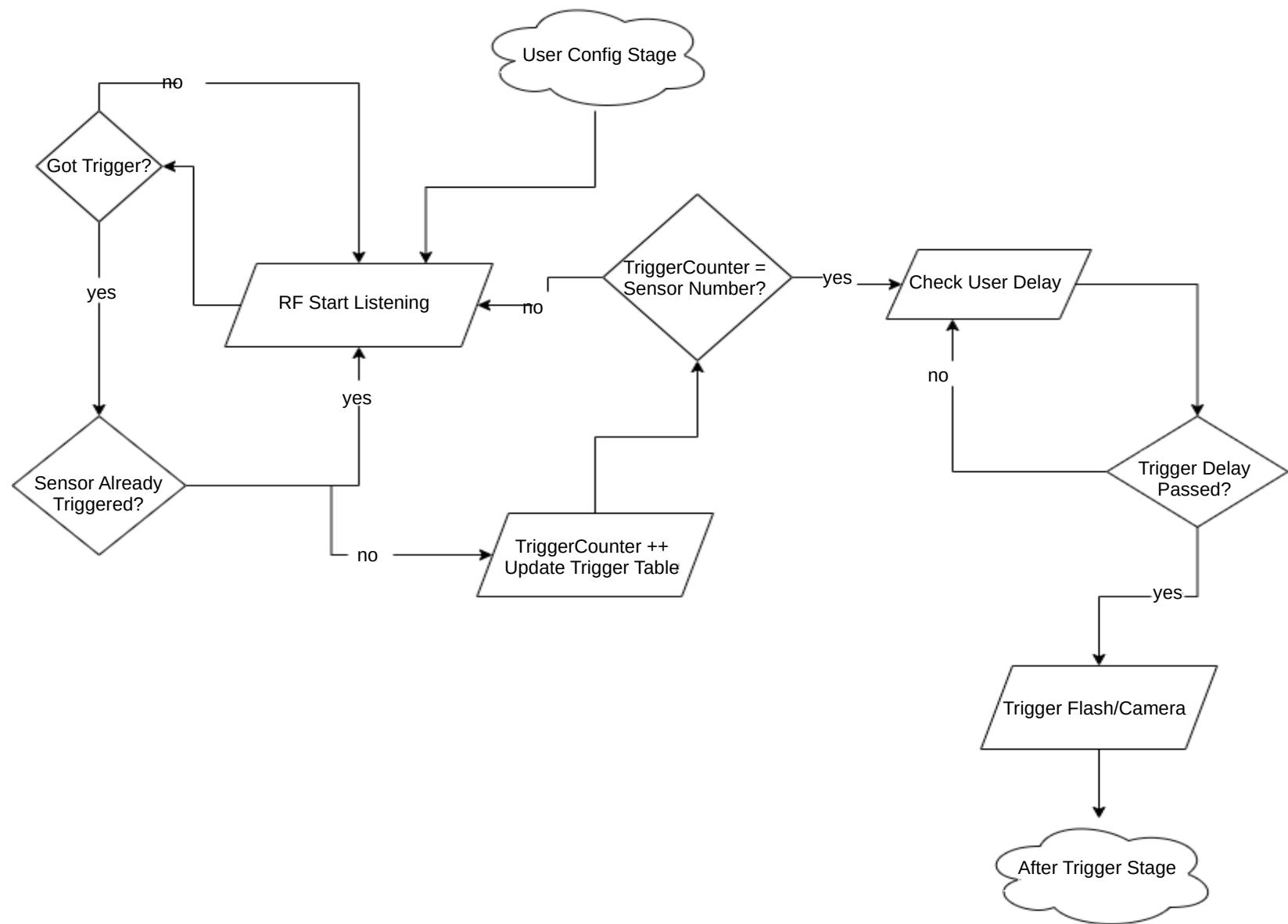
Configuration State : Base Subsystem



Triggering : Sensor Subsystem



Triggering : Base Subsystem



Photographic Equipment



<https://www.sony.com/electronics/interchangeable-lens-cameras/ilce-6000-body-kit>



<https://www.pinterest.co.uk/pin/299630181460781731/>

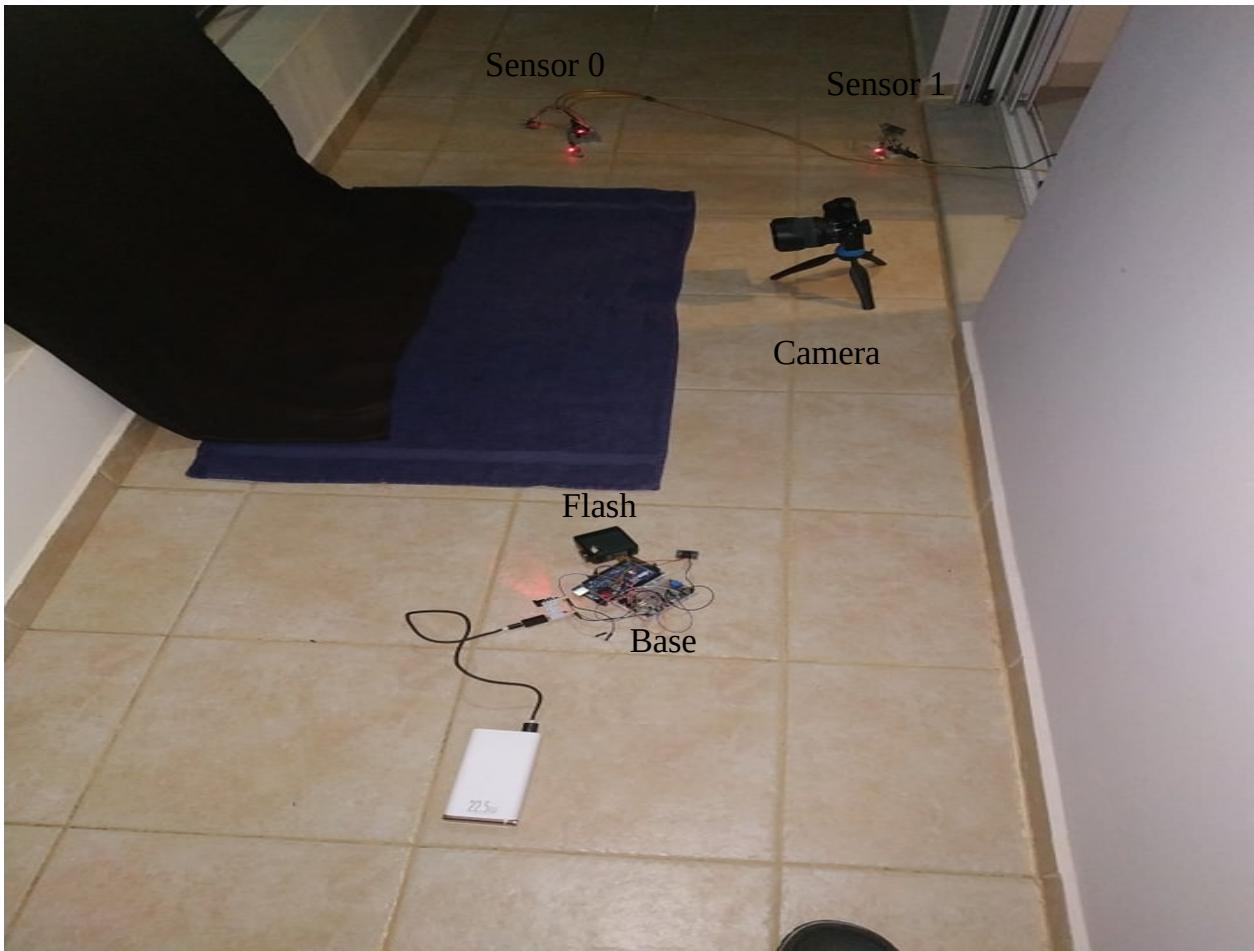
Camera

- Sony a6000
- Canon EOS 300D

Flash

- Fotomatic 140
- Yongnuo Speedlite YN560 IV
- Vivitar Auto 2600

Experimentation Site And Tested Cases



System Setup

Tested Cases

- Popping balloons
- Breaking of objects
- Falling objects on liquid surface

Inability to test

- Lightning
- Projectiles/Bullets
- Wild animals

Testing Parameters

Sound Sensors only

- Variable distances from objects → Change in total response time
- Slow response time → Correct operation on worst cases

Example with selected delay

- Better visual effect
- Test for the selected delay functionality

Images From Our System



Popping balloon

Popping balloon (filled with flour)

Phenomenon	Sensors	Distance	Selected delay
Popping balloon	1	5 cm	0 ms
Popping balloon (flour)	1	25 cm	0 ms

Images From Our System



Breaking vase

Breaking vase (with delay)

Phenomenon	Sensors	Distance	Selected delay
Breaking vase	1	15 cm	0 ms
Breaking vase (with delay)	1	15 cm	50 ms

Images From Our System



Falling object on liquid surface

Breaking egg

Phenomenon	Sensors	Distance	Selected delay
Falling object on liquid surface	2	30 cm/45 cm	0 ms
Breaking egg	1	30 cm	0 ms

Latency Measurement Method

Estimation :

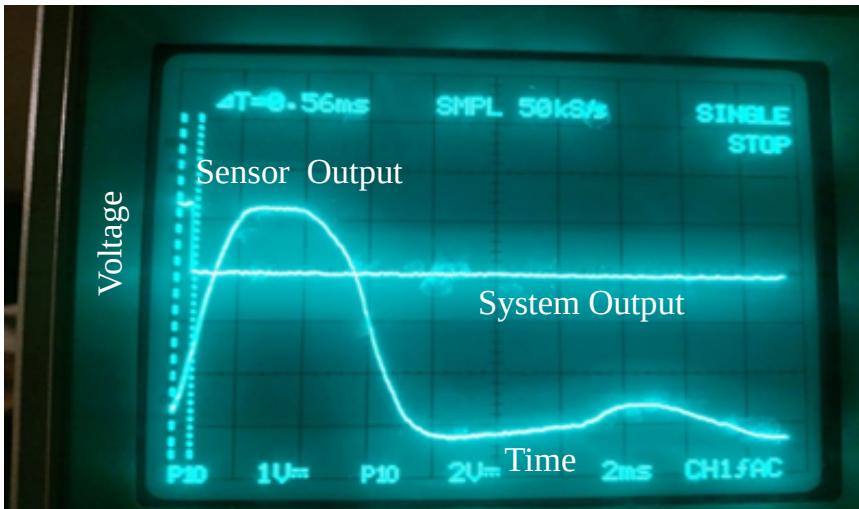
- Sensor data collection (~ 100 us)
- SPI communication with transmitter MCU (~ 16-32 us)
- RF Transceiver settling (~ 230 us)
- RF transmission (~ 90 us)
- SPI communication with receiver MCU (~ 32 us)
- Electrical Isolation Circuits and Triggering (~ 50 us)

Total : ~ 530 us

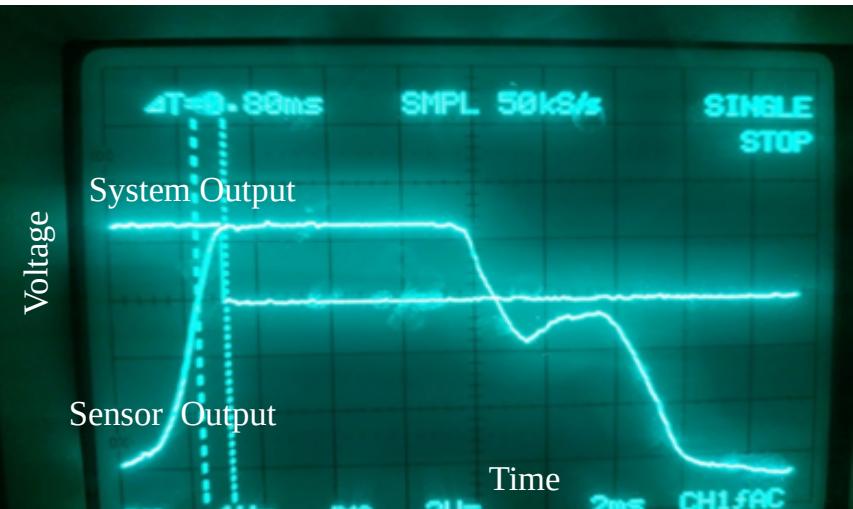
Measurements from oscilloscope waveforms

Use of LED instead of flash

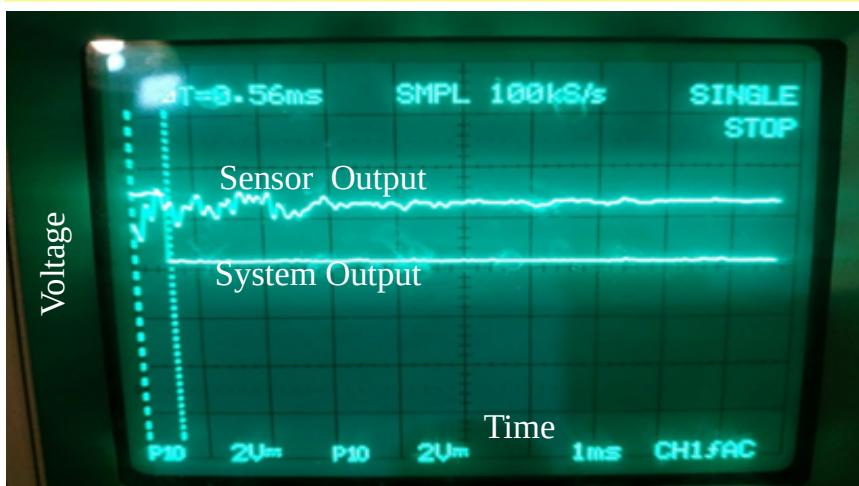
System Latency



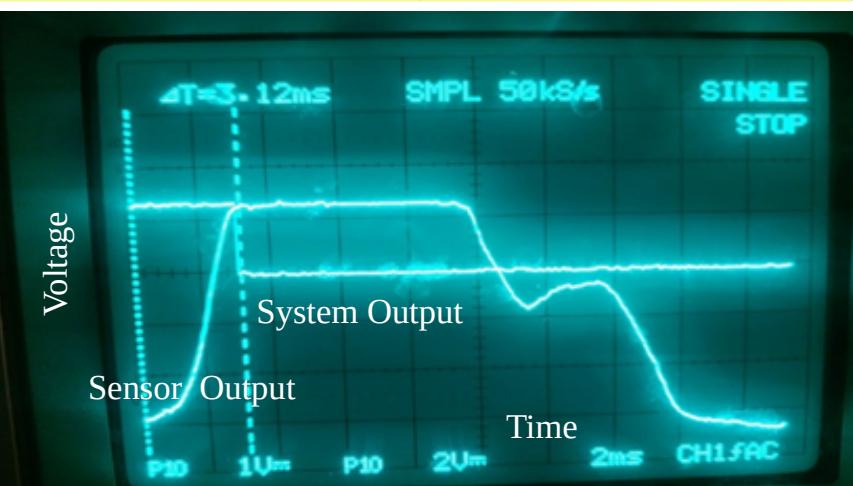
Example 1: Photodiode, Delay 0.56 ms



Example 2: Photodiode, Delay 0.8 ms



Example 3: Microphone, Delay 0.56 ms



Example 4: Photodiode, Delay 3.12 ms (sensor response)

Challenges

Resolved

- Constraining the program memory footprint to the available SRAM
- Support wide variety of flash voltages → Use of Opto TRIAC and SCR

Unresolved

- Maintain system consistency at all times
- Define a recovery procedure in case of system crash
- Changing trigger parameters after entering Triggering state

Conclusion

	Sensor Connection	Supported Sensors	System Latency	Voltage	Cost
Goal	Wireless	2	< 5 ms	3.3-5 V	< \$60
Achievement	Wireless	2	< 1 ms	5 V	< \$30

Other Achieved Goals

- Open source system
- Availability of used components
- Support for any flash up to 300 V

Concerns

- Higher latency compared to a wired system
- Risk of lost messages
- Need for more components

Outlook

Perspectives

- Recovery from system crash
- Parameters change after Configuration state
- Addition of more sensors
- Combination of wireless and wired sensors
- Fine tuning of libraries for even lower latency
- Design of custom PCB
- Improvement of user interface

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